



ZVP3310F

SOT23 P-CHANNEL ENHANCEMENT MODE VERTICAL DMOS FET

Product Summary

| BV _{DSS} | R _{DS(ON)} max | I _D max |
|-------------------|------------------------------|--------------------|
| -100V | 20Ω @ V _{GS} = -10V | -75mA |

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Load Switching

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>ZVP3310FQ</u>)

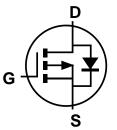
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (63)
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

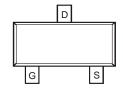
SOT23



Top View



Internal Schematic



Top View

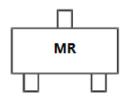
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|-------|------------------|
| ZVP3310FTA | SOT23 | 3000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



MR = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|---|--------------|-----------------|------|----|
| Drain-Source Voltage | | V_{DSS} | -100 | V |
| Gate-Source Voltage | | V_{GSS} | ±20 | V |
| Continuous Drain Current | Steady State | I _D | -75 | mA |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | I _{DM} | -1.2 | Α |
| Pulsed Source Current (10µs Pulse, Duty Cycle = 1%) | | I _{SM} | -1.2 | Α |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|-------------|------|
| Power Dissipation (@T _A = +25°C) | P _D | 330 | mW |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

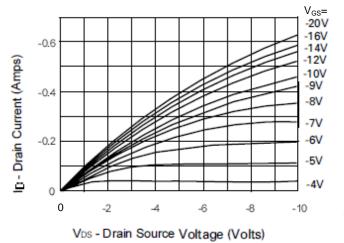
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

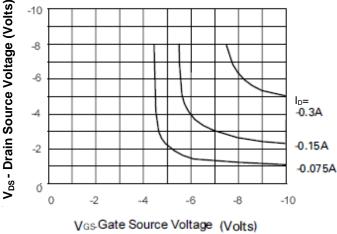
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|------|-----|------|------|--|--|
| OFF CHARACTERISTICS (Note 6) | <u> </u> | | - | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -100 | _ | _ | V | $V_{GS} = 0V$, $I_D = -1mA$ | |
| | I _{DSS} | _ | _ | -1 | μA | V _{DS} = -100V, V _{GS} = 0V | |
| Zero Gate Voltage Drain Current | | _ | _ | -50 | μA | V _{DS} = -80V, V _{GS} = 0V, T = +125°C | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±20 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 6) | | | | | | • | |
| Gate Threshold Voltage | V _{GS(TH)} | -1.5 | _ | -3.5 | V | $V_{DS} = V_{GS}$, $I_D = -1mA$ | |
| Static Drain-Source On-Resistance (Note 5) | R _{DS(ON)} | _ | _ | 20 | Ω | $V_{GS} = -10V, I_D = -150mA$ | |
| On-State Drain Current (Note 5) | I _{D(ON)} | -300 | _ | _ | mA | $V_{DS} = -25V, V_{GS} = -10V$ | |
| Forward Transconductance (Note 5) | gfs | 50 | _ | _ | mS | $V_{DS} = -25V, I_{D} = -150mA$ | |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | | |
| Input Capacitance | C _{iss} | _ | _ | 50 | | V _{DS} = -25V, V _{GS} = 0V, f = 1MHz | |
| Output Capacitance | Coss | _ | _ | 15 | pF | | |
| Reverse Transfer Capacitance | C _{rss} | _ | _ | 5 | | | |
| Turn-On Delay Time | t _{D(ON)} | _ | _ | 8 | | V _{DD} = -25V, I _D = -150mA | |
| Turn-On Rise Time | t _R | _ | _ | 8 | ns | | |
| Turn-Off Delay Time | t _{D(OFF)} | _ | _ | 8 | 1115 | | |
| Turn-Off Fall Time | t _F | _ | | 8 | | | |

Notes:

- 5. Measured under pulsed conditions. Width = 300ms. Duty cycle <=2%.6. Short duration pulse test used to minimize self-heating effect.
- 7. Guaranteed by design. Not subject to product testing.



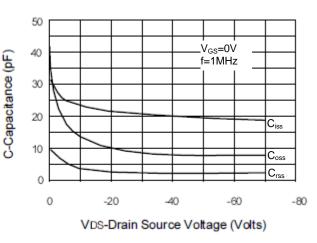




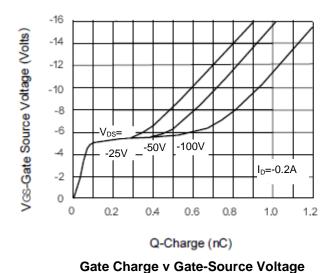
Saturation Characteristics

100 90 gfs-Transconductance (mS) V_{DS}=-10V 80 70 60 50 40 30 20 10 0 -0.1 -0.2 -0.3 -0.4 -0.5 -0.6 -0.7 -0.8 ID- Drain Current (Amps)

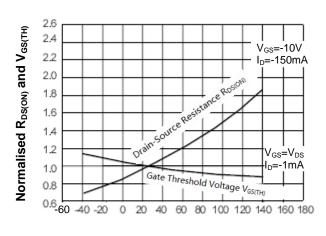
Voltage Saturation Characteristics



Transconductance v Drain Current



Capacitance v Drain-Source Voltage



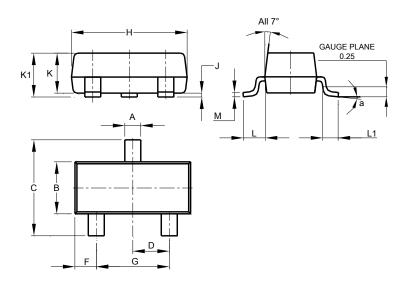
 $$T_{J}$$ - Junction Temperature (°C) Normalised $R_{DS(ON)}$ and $V_{GS(TH)}$ v Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

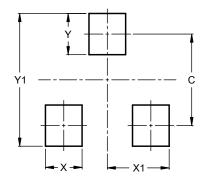


| SOT23 | | | | | |
|----------------------|-------|-------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.37 | 0.51 | 0.40 | | |
| В | 1.20 | 1.40 | 1.30 | | |
| С | 2.30 | 2.50 | 2.40 | | |
| D | 0.89 | 1.03 | 0.915 | | |
| F | 0.45 | 0.60 | 0.535 | | |
| G | 1.78 | 2.05 | 1.83 | | |
| Н | 2.80 | 3.00 | 2.90 | | |
| J | 0.013 | 0.10 | 0.05 | | |
| K | 0.890 | 1.00 | 0.975 | | |
| K1 | 0.903 | 1.10 | 1.025 | | |
| L | 0.45 | 0.61 | 0.55 | | |
| L1 | 0.25 | 0.55 | 0.40 | | |
| М | 0.085 | 0.150 | 0.110 | | |
| а | 0° | 8° | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 2.0 |
| Х | 0.8 |
| X1 | 1.35 |
| Y | 0.9 |
| Y1 | 2.9 |



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